國立清華⼤學電機資訊學院

114學年度國際半導體暨IC設計產業人才專班申請表

College of Electrical Engineering and Computer Science

National Tsing Hua University

Application Form for International Semiconductor and IC Design Program 2025

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| 1. **Personal Information 申請⼈資料** | | Photo  照片 |
| 申請件編號：(office use only) | |
| 英文姓名 (as in passport)  Family Name:  Given Name: | |
| 中文姓名 (optional) | |
| 郵件帳號 | ⽣⽇ (year/month/date) | |
| 出⽣地 | **Nationality** 國籍 | |
| 護照號碼 (If applicable) | Biological Gender 性別 : M(男) F(女) | |
| Contact Information 聯絡資料 | | |
| ⼾籍地址 | | |
| Street 街道:  City 城市:  Country 國家:  Zip code 郵遞區號: | | |
| E-mail 電子信箱: | | |
| Contact Phone/Mobile Phone 電話: (country code)+(phone number ) | | |
| 緊急聯絡⼈ | | |
| 姓名:  關係:  電話:  電⼦信箱:  地址: | | |

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| 1. Education Background **教育背景** | | | |
| **Highest Degree Received** | | | |
| Name of Institution 學校名稱: | | | |
| Major in 系所: | | | |
| School Address 學校地址  Street: | | | |
| City:  Postal/ Zip Code: | State/ Province:  Country: | | |
| Date of Graduation 畢業年月: (MM-DD-YYYY ) | | | |
| Average GPA: of | | |  |
|  | | | |
| **Others** | | | |
| School Name 學校名稱: | | | |
| Department or Focused Area 系所或專業領域: | | | |
| School Address 學校地址  Street: | | | |
| City:  Postal/ Zip Code: | State/ Province:  Country: | | |
| Date of Graduation 畢業年月: (MM-DD-YYYY ) | | | |
| Average GPA: of | |  | |
|  | | | |
| **Others** | | | |
| School Name 學校名稱: | | | |
| Department or Focused Area 系所或專業領域: | | | |
| School Address 學校地址  Street: | | | |
| City:  Postal/ Zip Code: | State/ Province:  Country: | | |
| Date Graduated 畢業年月: (MM-DD-YYYY ) | | | |
| Average GPA: of | | | |
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| 1. **Mentionable Activity 亮點活動** | | | | | | | | |
| You may list your mentionable achievements, work experience (if any), and other relevant experiences. | | | | | | | | |
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| 1. **Other Information 其他資訊** | | | | | | | |
| 在清華⼤學就學期間經濟來源 | | | | | | | |
| □ Personal savings (個⼈存款)  □ Other, please specify (其他，說明)  □ Scholarships, please specify (獎學⾦，說明) | | | | | | | |
| 語⾔能⼒ | | | | | | | |
| 英文 | | | | | | | |
| □Fluent 傑出 | □ Good 優秀 | | | | □ Moderate 好 | □ Limited 普通 | □ None 差 |
| 中文 | | | | | | | |
| □ Fluent 傑出 | □ Good 優秀 | | | | □ Moderate 好 | □ Limited 普通 | □ None 差 |
| 其他語⾔: | | | | | | | |
| □ Fluent 傑出 | □ Good 優秀 | | | | □ Moderate 好 | □ Limited 普通 | □ None 差 |
| 住宿申請 | | | | | | | |
| **If available, are you interested in applying on-campus housing?** 請問是否需要申請住宿  □ Yes □ No | | | | | | | |
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| 1. **Contacts for Recommendation Letters** | | | | | | | |
| **Referee** 推薦人 1 | | | | | | | |
| Name 姓名: | | | |  | | | |
| Current Position/Job Title 現職名稱: | | | |  | | | |
| Current Employer 現職單位: | | | |  | | | |
| E-mail 電⼦郵件: | | | |  | | | |
| Relationship with the applicant  與申請人之關係: | | | |  | | | |
| **Referee** 推薦人 2 | | | | | | | |
| Name 姓名: | | |  | | | | |
| Current Position/Job Title 現職名稱: | | |  | | | | |
| Current Employer 現職單位: | | |  | | | | |
| E-mail 電⼦郵件: | | |  | | | | |
| Relationship with the applicant 與申請人之關係: | |  | | | | | |

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| 1. Statement of Purpose **學習計畫** |
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| **Do you have preferred host professors 希望的指導教授？**  🞏 Yes 🞏 No  **Have already contacted him/her 您是否已經與這位教授連繫？**  🞏 Yes 🞏 No |
| Professor’s Name 教授姓名: |
| Department/Institute 系別: |
| E-mail 電⼦郵件: |

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| 國立清華⼤學電機資訊學院  114學年度國際半導體暨IC設計產業人才專班申請表  College of Electrical Engineering and Computer Science  National Tsing Hua University  Application Form for International Semiconductor and IC Design Program 2025  **Application Checking List** | | | |
| Application Number: (office use only) | | | |
| Applicant: | | |  |
| Nationality: | | |  |
| **NOTE** Please have the outgoing exchange program coordinator at your home institution to check your required documents and complete the following session I and II. | | | |
| **Section I**  Application Package | **List of General Required Documents** | | |
| 🞏 | **Application Form with Statement of Purpose** | |
| 🞏 | An official copy of the **Transcript** (English) | |
| 🞏 | A copy of your highest **Degree Diploma** | |
| 🞏 | **Recommendation Letters** (Referees’ Contacts) | |
| 🞏 | **Language Certificate**   * English Proficiency Test 🞏 Chinese Proficiency Test | |
| 🞏 | A Copy of **Passport Identity page** (valid for at least 3 months) or nationality verification | |
| 🞏 | **Financial Certificate** | |
| 🞏 | **Declaration Form** | |
| **Section II**  Applicant’s Statement | **Certification** | | |
| I certify that the information I have provided in this application is complete and correct. I understand that any misrepresentation, omission, or submission of false information is grounds for rejection of my application, withdrawal of acceptance, cancellation of enrollment, and/or disciplinary action at a future date. If my application is accepted, I agree to abide by the policies, rules, and regulations of the Republic of China and National Tsing Hua University. | | |
| **Applicant’s Signature (簽名)：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ Date:** | | |